# **ERB05GG**

# GLASS PASSIVATED FAST RECOVERY RECTIFIER

VOLTAGE:400 CURRENT: 0.5A



## **FEATURE**

Molded case feature for auto insertion
High current capability
Low leakage current
Fast switching capability
High temperature soldering guaranteed
250℃ /10sec/0.375" lead length at 5 lbs tension
Glass Passivated chip

#### **MECHANICAL DATA**

Terminal: Plated axial leads solderable per

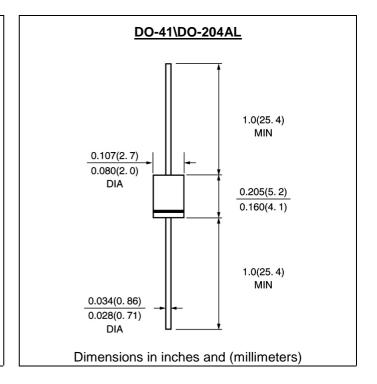
MIL-STD 202E, method 208C

Case: Molded with UL-94 Class V-0 recognized Flame

Retardant Epoxy

Polarity: color band denotes cathode

Mounting position: any



## MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half-wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated)

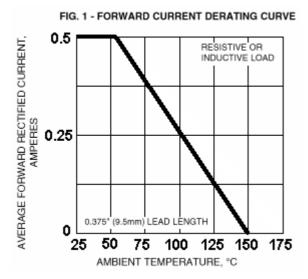
		SYMBOL	ERB05GG	units
Maximum Recurrent Peak Reverse Voltage		Vrrm	400	V
Maximum RMS Voltage		Vrms	280	V
Maximum DC blocking Voltage		Vdc	400	V
Maximum Average Forward Rectified Current 3/8"lead length at Ta =55 $^{\circ}$ C		If(av)	0.5	А
Peak Forward Surge Current 8.3ms single half sine- wave superimposed on rated load		Ifsm	10.0	А
Maximum Forward Voltage at rated Forward Current and 25 $^{\circ}\!$		Vf	1.2	V
Maximum full load reverse current full cycle average at $55^{\circ}\!$		Ir(av)	100.0	μА
Maximum DC Reverse Current	Ta =25℃	lr	5.0	μА
at rated DC blocking voltage	Ta =150°C	"	100.0	μA
Maximum Reverse Recovery Time	(Note 1)	Trr	150	nS
Typical Junction Capacitance	(Note 2)	Cj	15.0	pF
Typical Thermal Resistance	(Note 3)	Rth(ja)	55.0	°C /W
Storage and Operating Junction Temperature		Tstg, Tj	-55 to +150	$^{\circ}$

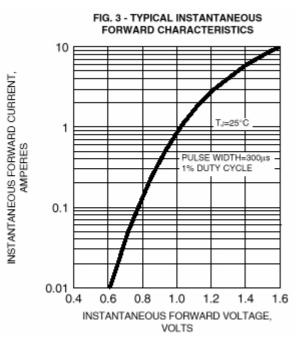
#### Note:

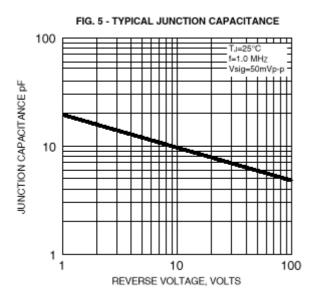
- 1. Reverse Recovery Condition If =0.5A, Ir =1.0A, Irr =0.25A
- 2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
- 3. Thermal Resistance from Junction to Ambient at 3/8"lead length, P.C. Board Mounted

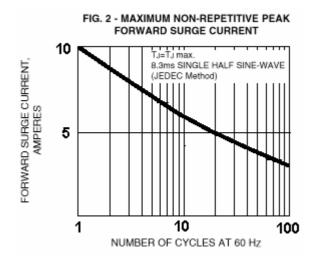
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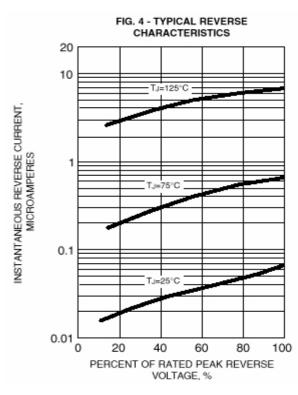
#### RATINGS AND CHARACTERISTIC CURVES ERB05GG

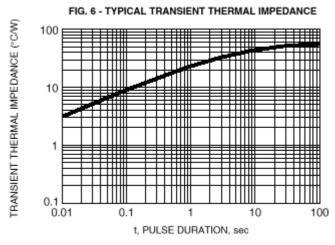












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